

L1	102	(US-20020089067-\$ or US-20020105092-\$ or US-20020114144-\$ or US-20020167079-\$ or US-20020173074-\$ or US-20030096453-\$ or US-20040082107-\$ or US-20040185601-\$ or US-20040187306-\$ or US-20040261904-\$).did. or (US-3839727-\$ or US-4143456-\$ or US-5203076-\$ or US-5218234-\$ or US-5385869-\$ or US-5450283-\$ or US-5535101-\$ or US-5697148-\$ or US-5700723-\$ or US-5710071-\$ or US-5766982-\$ or US-5817545-\$ or US-5834339-\$ or US-5849606-\$ or US-5935375-\$ or US-5942798-\$ or US-5973930-\$ or US-5981312-\$ or US-5981313-\$ or US-5998242-\$ or US-5998243-\$ or US-6000924-\$ or US-6027590-\$ or US-6046076-\$ or US-6048656-\$ or US-6074897-\$).did. or (US-6081997-\$ or US-6093972-\$ or US-6107689-\$ or US-6121689-\$ or US-6130476-\$ or US-6157086-\$ or US-6160308-\$ or US-6168972-\$ or US-6201301-\$ or US-6220503-\$ or US-6225704-\$ or US-6228688-\$ or US-6238948-\$ or US-6245583-\$ or US-6245595-\$ or US-6251766-\$ or US-6255142-\$ or US-6264094-\$ or US-6285560-\$ or US-6297560-\$ or US-6309908-\$ or US-6324069-\$ or US-6329224-\$ or US-6331446-\$ or US-6333563-\$ or US-6335491-\$ or US-6365435-\$).did. or (US-6365441-\$ or US-6383846-\$ or US-6391682-\$ or US-6435396-\$ or US-6438826-\$ or US-6445074-\$ or US-6448665-\$ or US-6451625-\$ or US-6459152-\$ or US-6459159-\$ or US-6468832-\$ or US-6489180-\$ or US-6490166-\$ or US-6495083-\$ or US-6498054-\$ or US-6506681-\$ or US-6528345-\$ or US-6534345-\$ or US-6537482-\$ or US-6545869-\$ or US-6599775-\$ or US-6610559-\$ or US-6656773-\$ or US-6660560-\$ or US-6661102-\$ or US-6661939-\$ or US-6674172-\$).did. or (US-6677179-\$ or US-6693239-\$ or US-6700209-\$ or US-6703299-\$ or US-6724091-\$ or US-6772512-\$ or US-6774497-\$ or US-6794623-\$ or US-6794761-\$ or US-6815258-\$ or US-6821878-\$ or US-6844052-\$).did.	US-PGPUB; USPAT	OR	ON	2005/03/17 10:15
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L2	22	1 and (((channel hole) with (underfill\$3 (under adj fill\$3))) with (carrer substrate))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 10:20
L3	198	(((channel hole) with (underfill\$3 (under adj fill\$3))) with (carrer substrate board))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 10:21
L4	165	3 and (chip die ic (semiconductor near1 (element device))) and (bump ball)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 10:22
L5	143	4 not 2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/17 10:22
L6	0	("6756251").URPN.	USPAT	OR	ON	2005/03/17 10:24

L7	89	("20010167092" "20020164838" "20030164540" "20030164541" "20030164543" "20030164548" "20030164551" "20030166312" "4807021" "5347159" "5366794" "5385869" "5386341" "5397921" "5409865" "5422205" "5448511" "5646446" "5663530" "5668405" "5674785" "5697148" "5710071" "5719449" "5721151" "5739585" "5747982" "5752182" "5758413" "5798285" "5805422" "5818113" "5834338" "5834366" "5835355" "5843808" "5844168" "5866953" "5886408" "5891753" "5898224" "5973404" "5977640" "5982030" "5984691" "5991161" "6008543" "6011694" "6024584" "6027346" "6028365" "6040630" "6050832" "6057178" "6072233" "6074897" "6075710" "6079991" "6093035" "6116921" "6124631" "6127736" "6137062" "6137164" "6137183" "6157541" "6165885" "6172422" "6179598" "6208521" "6212768" "6214156" "6218202" "6219911" "6221763" "6225688" "6229711" "6262895" "6291775" "6294455" "6300679" "6310288" "6323060" "6413102" "6429516" "6432737" "6489687" "6492737" "6518677" "6552910").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/17 10:24
L8	1	("6057178").URPN.	USPAT	OR	ON	2005/03/17 10:27
L9	3	("5328060" "5697148" "5731223").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/17 10:27
L10	20	("6081997").URPN.	USPAT	OR	ON	2005/03/17 10:43